

Turbo 2 ultrafast high voltage rectifier

Main product characteristics

I _{F(AV)}	20 A
V _{RRM}	600 V
T _j	175° C
V _F (typ)	1.0 V
t _{rr} (max)	50 ns

Features and benefits

- Ultrafast switching
- Low reverse current
- Low thermal resistance
- Reduces switching and conduction losses

Description

The STTH2006 uses ST Turbo 2 600 V technology and is especially suited for use in switching power supplies, and industrial applications, such as red fication and continuous mode PFC boost diode.



Order Codes

Part Number	Marking
STTH2006W	STTH2006W

Table 1. Absolute Ratings ('initing values)

Symbol	Pa	arameter		Value	Unit
V _{RF.M}	Repetitiv : pr ar reverse voltage			600	V
I _{F(RMS)}	RMS icrward voltage			50	Α
I _{F(AV)}	Average forward current		$T_c = 120^{\circ} \text{ C} \delta = 0.5$	20	Α
IFAN	Surge non repetitive forward curren	ıt	t _p = 10 ms sinusoidal	160	Α
T _{stg}	Storage temperature range			-65 to + 175	° C
T _j	Maximum operating junction tempe	rature		175	°C

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Characteristics 1

Table 2. Thermal resistance

Symbol	Parameter	Value (max).	Unit
R _{th(j-c)}	Junction to case	1.1	°C/W

Table 3. Static electrical characteristic

Symbol	Parameter	Test co	nditions	Min.	Тур	Max.	Unit
I _R ⁽¹⁾	Reverse leakage	T _j = 25° C	V - V			25	uА
'R`	current	T _j = 150° C	$V_R = V_{RRM}$		80	800	SIA
V _E ⁽²⁾	Forward voltage drop	T _j = 25° C	I _F = 20 A			1.7.5	V
VF \	Forward voltage drop	T _j = 150° C	1F = 20 A		1.00	1.35	V

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2\%$

Table 4. Symbol	Dynamic char Parameter		7 est conditions	Min.	Тур	Max.	Unit
	Reverse recovery		$I_F = 0.5 \text{ A}$ $I_{rr} = 0.25 \text{ A}$ $I_R = 1 \text{ A}$			50	
t _{rr}	time	1;) = 2:5° C	$I_F = 1 \text{ A} dI_F/dt = -50 \text{ A/}\mu\text{s}$ $V_R = 30 \text{ V}$		50	70	ns
I _{RM}	Reverse recovery cur ent	T _j = 125° C	$I_F = 30 \text{ A}$ $V_R = 400 \text{ V}$ $dI_F/dt = -100 \text{ A/µs}$		8	11	Α
t _{fr}	Forward recovery time	T _j = 25 °C	$I_F = 30 \text{ A}$ $dI_F/dt = 100 \text{ A/}\mu\text{s}$ $V_{FR} = 1.1 \text{ x } V_{Fmax}$			500	ns
V _{FP}	Forward recovery voltage	T _j = 25° C	$I_F = 30 \text{ A}$ $dI_F/dt = 100 \text{ A/}\mu\text{s}$ $V_{FR} = 1.1 \text{ x } V_{Fmax}$		2.5		٧
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STTH2006 Characteristics

Figure 1. Conduction losses versus average forward current

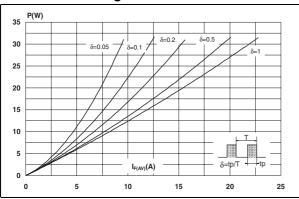


Figure 2. Forward voltage drop versus forward current

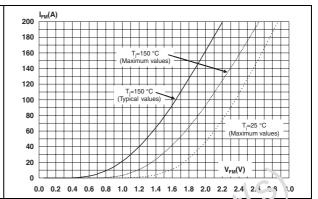
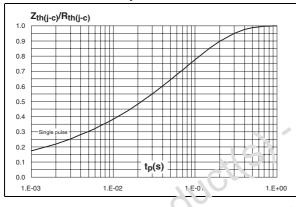


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

Figure 4. Peak reverse recovery current versus dl_F/dt (typical values)



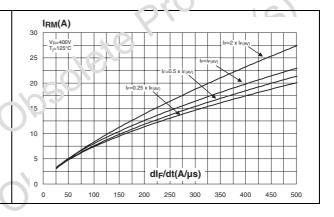


Figure 5. Reverse ration ery time versus dl_F/dt (typical values)

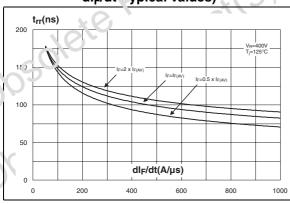
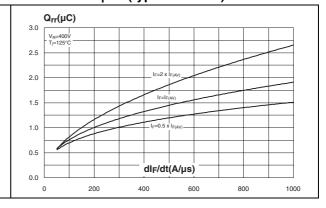


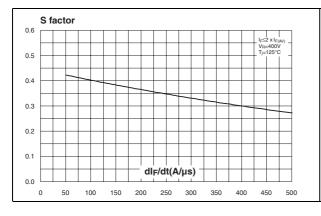
Figure 6. Reverse recovery charges versus dl_F/dt (typical values)



Characteristics STTH2006

Figure 7. Softness factor versus dI_F/dt (typical values)

Figure 8. Relative variations of dynamic parameters versus junction temperature



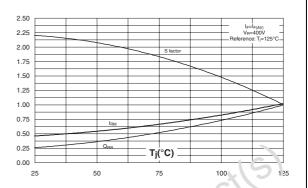
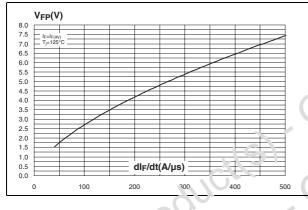


Figure 9. Transient peak forward voltage versus dl_F/dt (typical values)

Figure 10. Forward recovery vince versus dl_F/dt (typical values)



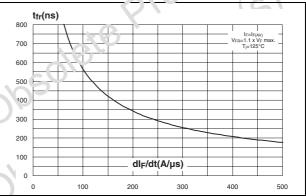
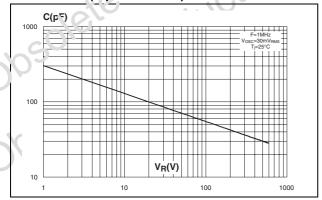


Figure 11. Junction & oacitance versus reverse voltage applied (typical values)



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STTH2006 **Package information**

Package information 2

Epoxy meets UL94, V0

Cooling method: by conduction (C) Recommended torque value: 0.55 Nm Maximum torque value: 0.70 Nm

Table 5. **DO-247 Package dimensions**

				Dimer	nsions		
	Ref.	Mi	illimete	rs		Inches	
		Min.	Тур.	Max.	Min.	1 _{.′} p.	Max.
	Α	4.85		5.15	0.13		0.203
V →n+	D	2.20		2.00	少.086		0.102
	Е	0.40	O	ე.80	0.015	Ne	0.031
V	F	1 00		1.40	0.039		0.055
<u>i</u>	F2	Sr.	2.00		10	0.078	
	1.3	2.00		2.40	0.078		0.094
	G		10.90			0.429	
	Н	15.45)	15.75	0.608		0.620
	L	19.85		20.15	0.781		0.793
	121	3.70		4.30	0.145		0.169
L3 V2 - F3 - D4	L2		18.50			0.728	
	L3	14.20		14.80	0.559		0.582
M E	L4		34.60			1.362	
10°	L5		5.50			0.216	
76, 200	М	2.00		3.00	0.078		0.118
50.	V		5°			5°	
	V2		60°			60°	
1010	Dia.	3.55		3.65	0.139		0.143
In order to meet environmental requirements packages. These packages have a lead-free second level interconnect is marked on the p compliance with JEDEC Standard JESD97.	secono ackage	d level in a second	interco n the ir	nnect. nner bo	The ca	itegory I, in	of

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Ordering information STTH2006

3 Ordering information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STTH2006W	STTH2006W	DO-247	4.40 g	30	Tube

4 Revision history

	Date	Revision	Changes	*(5)
	13-Jul-2006	1	Initial release.	11100
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			187	"ICIL"
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			000	
			el eleje	
		,cil	310050	
	10	ducti	0/050	
	Pro	ducti	Initial release.	
	ete Pro	ducti	51,000	
-10501	ste Pro	ducti	5) 0050	
Obsol	ete Pro	ducti	51,005	
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